



Metalon® Conductive Inks for Printed Electronics

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Metalon® HPSC-U349

High Conductivity Silver-Coated Copper Screen Ink

GENERAL INFORMATION

Particle: 3-micron silver-coated copper particles (49% w/w Cu)

Substrates: Paper, plastics, glass, metals

Features:

- Economical pricing
- High metal loading (87% w/w metal)
- High conductivity for low temperature curing
- Excellent water and alcohol resistance
- Flexible and good adhesion
- Printing equipment cleans with isopropanol
- Conductivity can be adjusted with Ag amount
- Solderable

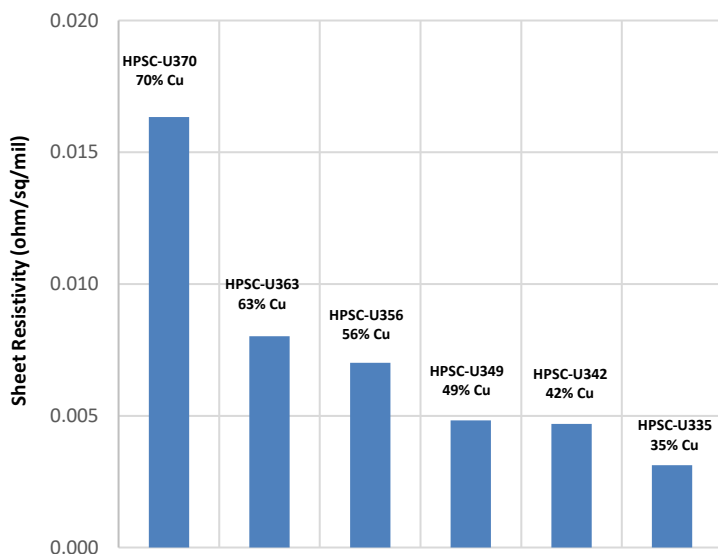
THERMAL CURE DATA

Cure Temperature ¹ (°C)	Cure Time (minutes)	Volume Resistivity ² (Ω-cm)	Sheet Resistivity ² (Ω/sq/mil)
80	120	5.1E-05	0.020
100	120	3.5E-05	0.014
120	30	2.0E-05	0.008
140	30	1.2E-05	0.005
150	15	1.2E-05	0.005
175	15	1.2E-05	0.005
200	10	1.2E-05	0.005

¹Pre-cure drying at 140C for 10 minutes for cure ≥ 175C

²Typical value (#10 drawdown and 25% porosity - typical dried coating 0.013g/cm²)

HPSC-U Silver-coated copper inks (cured at 140C)



Physical Properties	General description.....	Ag-coated Cu particle ink
	Viscosity (typical values)...	127,000 cP at 10 sec ⁻¹ 55,000 cP at 100 sec ⁻¹
	Specific gravity.....	4.5
	Particle size.....	D50 - 3 microns
	Metal content.....	87% w/w
Storage and Printing	Storage.....	Room temperature
	Shelf life.....	> 6 months
	Cleaning solvent.....	Isopropanol
	Screen mesh material.....	Stainless steel or polyester
	Screen mesh count.....	325 to 80 wires per inch
Shipping and Packaging	MOQ - 100 grams	

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Contact us today to learn more.
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